

## Insulated Hyperfast Rectifier Module, 280 A

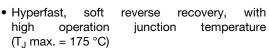


**SOT-227** 

PRIMARY CHARACTERISTICS					
$V_{R}$	300 V				
$I_{F(AV)}$ per module at $T_C = 81  ^{\circ}C$	280 A				
t <sub>rr</sub>	58 ns				
Type	Modules - Diode FRED Pt®				
Package	SOT-227				
Circuit configuration	Two separate diodes, parallel pin-out				

#### **FEATURES**

- Two fully independent diodes
- · Fully insulated package





RoHS COMPLIANT

- Low forward voltage drop
- · Optimized for power conversion: welding and industrial SMPS applications
- · Easy to use and parallel
- · Industry standard outline
- UL approved file E78996



- · Designed and qualified for industrial level
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **DESCRIPTION / APPLICATIONS**

The VS-UFH280FA30 insulated modules integrate two state of the art ultrafast recovery rectifiers in the compact, industry standard SOT-227 package. The diodes structure, and its life time control, provide an ultrasoft recovery current shape, together with the best overall performance, ruggedness and reliability characteristics.

These devices are thus intended for high frequency applications in which the switching energy is designed not to be predominant portion of the total energy, such as in the output rectification stage of welding machines, SMPS, DC/DC converters. Their extremely optimized stored charge and low recovery current reduce both over dissipation in the switching elements (and snubbers) and EMI/RFI.

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS		
Cathode to anode voltage	$V_R$		300	V		
Continuous forward current per diode	I <sub>F</sub>	T <sub>C</sub> = 95 °C	160	۸		
Single pulse forward current per diode	I <sub>FSM</sub>	T <sub>C</sub> = 25 °C	1539	A		
Maximum power dissipation per module	P <sub>D</sub>	T <sub>C</sub> = 95 °C	410	W		
RMS isolation voltage	V <sub>ISOL</sub>	Any terminal to case, t = 1 minute	2500	V		
Operating junction and storage temperatures	T <sub>J</sub> , T <sub>Stg</sub>		-55 to +175	°C		

<b>ELECTRICAL SPECIFICATIONS PER DIODE</b> (T <sub>J</sub> = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	$V_{BR}$	I <sub>R</sub> = 200 μA	300	-	-	
Forward voltage		I <sub>F</sub> = 100 A	-	1.07	1.27	V
	$V_{FM}$	I <sub>F</sub> = 100 A, T <sub>J</sub> = 175 °C	-	0.82	-	
Develop legicage overent		V <sub>R</sub> = V <sub>R</sub> rated	-	0.5	100	μΑ
Reverse leakage current	IRM	T <sub>J</sub> = 175 °C, V <sub>R</sub> = V <sub>R</sub> rated	-	0.74	-	mA
Junction capacitance	C <sub>T</sub>	V <sub>R</sub> = 300 V	-	216	-	pF



<b>DYNAMIC RECOVERY CHARACTERISTICS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Reverse recovery time t <sub>rr</sub>	+	T <sub>J</sub> = 25 °C	I <sub>F</sub> = 50 A dI <sub>F</sub> /dt = 200 A/μs V <sub>R</sub> = 200 V	-	58	-	ns
	L <sub>rr</sub>	T <sub>J</sub> = 125 °C		-	85	-	
Peak recovery current	I <sub>RRM</sub>	T <sub>J</sub> = 25 °C		=	4.5	-	A nC
		T <sub>J</sub> = 125 °C		-	10	-	
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	130	-	
		T <sub>J</sub> = 125 °C		-	429	=	

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Junction-to-case, single leg conducting	D		-	-	0.39	
Junction-to-case, both leg conducting	$R_{thJC}$		-	-	0.195	°C/W
Case-to-heatsink	R <sub>thCS</sub>	Flat, greased surface	-	0.1	-	
Weight			-	30	-	g
Mounting torque		Torque to terminal	-	-	1.1 (9.7)	Nm (lbf.in)
Mounting torque		Torque to heatsink	-	-	1.8 (15.9)	Nm (lbf.in)
Case style				S	OT-227	

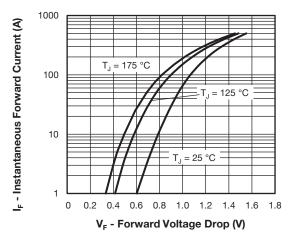


Fig. 1 - Typical Forward Voltage Drop vs. Instantaneous Forward Current (Per Diode)

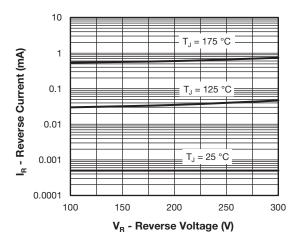


Fig. 2 - Typical Reverse Current vs. Reverse Voltage (Per Diode)

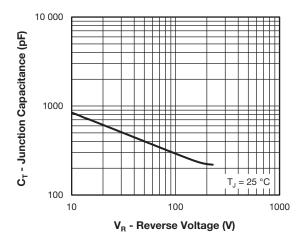


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Diode)



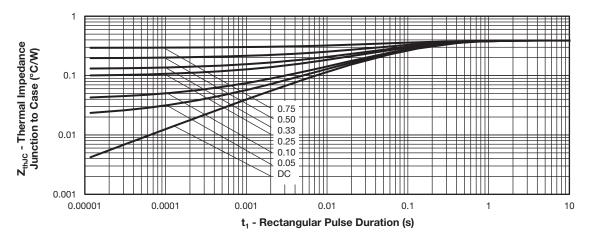


Fig. 4 - Maximum Thermal Impedance ZthJC Characteristics (Per Diode)

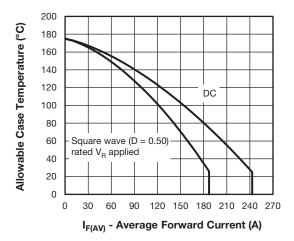


Fig. 5 - Maximum Current Rating Capability (Per Diode)

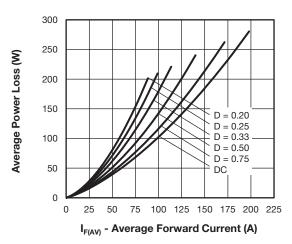


Fig. 6 - Forward Power Loss Characteristics (Per Diode)

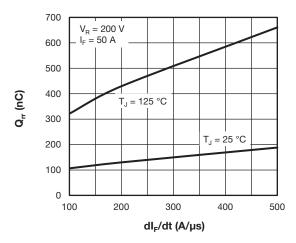


Fig. 7 - Typical Reverse Recovery Charge vs. dl<sub>F</sub>/dt (Per Diode)

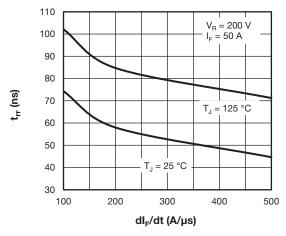


Fig. 8 - Typical Reverse Recovery Time vs. dl<sub>F</sub>/dt (Per Diode)

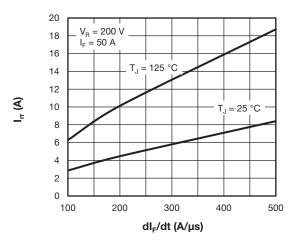


Fig. 9 - Typical Reverse Recovery Current vs. dI<sub>F</sub>/dt (Per Diode)

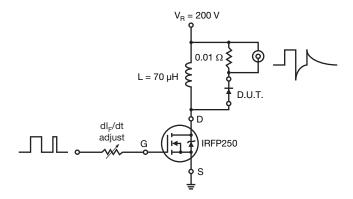
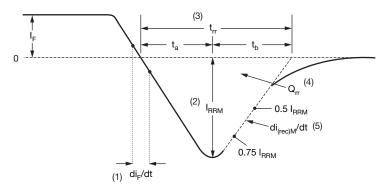


Fig. 10 - Reverse Recovery Parameter Test Circuit



- (1) di<sub>F</sub>/dt rate of change of current through zero crossing
- (2) I<sub>RRM</sub> peak reverse recovery current
- (3)  $\rm t_{rr}$  reverse recovery time measured from zero crossing point of negative going  $\rm I_F$  to point where a line passing through 0.75  $\rm I_{RRM}$  and 0.50  $\rm I_{RRM}$  extrapolated to zero current.
- (4)  $\mathbf{Q}_{rr}$  area under curve defined by  $\mathbf{t}_{rr}$  and  $\mathbf{I}_{RRM}$

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

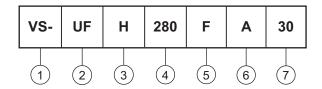
(5) di<sub>(rec)M</sub>/dt - peak rate of change of current during t<sub>b</sub> portion of t<sub>rr</sub>

Fig. 11 - Reverse Recovery Waveform and Definitions



#### **ORDERING INFORMATION TABLE**

**Device code** 



1 - Vishay Semiconductors product

2 - Ultra fast rectifier

Hyper fast FRED Pt® diffused

4 - Current rating (280 = 280 A)

5 - Circuit configuration (2 separate diodes, parallel pin-out)

6 - Package indicator (SOT-227 standard insulated base)

7 - Voltage rating (30 = 300 V)

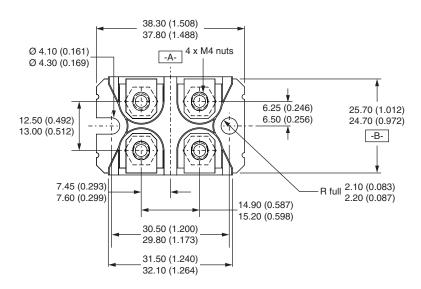
CIRCUIT CONFIGURATION					
CIRCUIT	CIRCUIT CONFIGURATION CODE	CIRCUIT DRAWING			
2 separate diodes, parallel pin-out	F	Lead Assignment  4 0 0 3 4 1 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0			

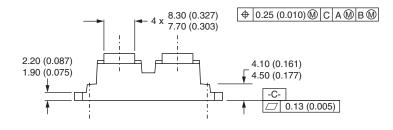
LINKS TO RELATED DOCUMENTS							
Dimensions	www.vishay.com/doc?95423						
Packaging information	www.vishay.com/doc?95425						

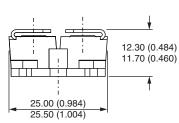


### **SOT-227 Generation II**

#### **DIMENSIONS** in millimeters (inches)







#### Note

Controlling dimension: millimeter



## **Legal Disclaimer Notice**

Vishay

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